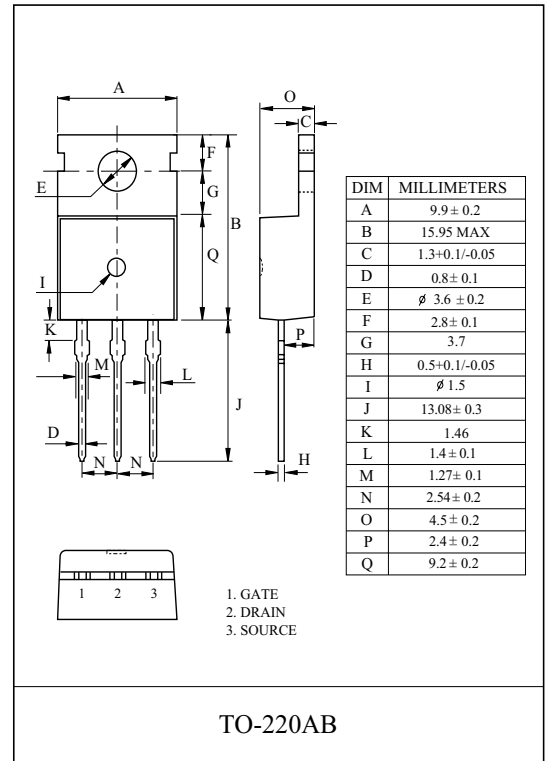


General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for active power factor correction, electronic lamp ballasts based on half bridge topology and switching mode power supplies.

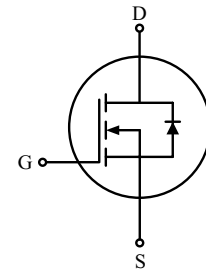
FEATURES

- $V_{DSS} = 60V$, $I_D = 50A$
- Drain-Source ON Resistance :
 $R_{DS(ON)} = 0.022 \Omega @ V_{GS} = 10V$
- $Q_g(\text{typ.}) = 32nC$
- Improved dv/dt capacity, high Ruggedness
- Maximum Junction Temperature Range (175 °C)



MAXIMUM RATING (Tc=25 °C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V_{GSS}	±20	V
Drain Current	@T _c =25 °C	50	A
	@T _c =100 °C	35	
	Pulsed (Note1)	200	
Single Pulsed Avalanche Energy (Note 2)	E_{AS}	493	mJ
Repetitive Avalanche Energy (Note 1)	E_{AR}	12	mJ
Peak Diode Recovery dv/dt (Note 3)	dv/dt	7.0	V/ns
Drain Power Dissipation	T _c =25 °C	120	W
	Derate above 25 °C	0.8	W/ °C
Maximum Junction Temperature	T _j	175	°C
Storage Temperature Range	T _{stg}	-55 ~ 175	°C
Thermal Characteristics			
Thermal Resistance, Junction-to-Case	R _{thJC}	1.24	°C/W
Thermal Resistance, Case-to-Sink	R _{thCS}	0.5	°C/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	°C/W



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ELECTRICAL CHARACTERISTICS (Tc=25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	60	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_j$	$I_D=250\mu A$, Referenced to 25 °C	-	0.07	-	V/°C
Drain Cut-off Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$,	-	-	10	μA
Gate Threshold Voltage	V_{th}	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=25A$	-	0.018	0.022	Ω
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=48V, I_D=50A$ $V_{GS}=10V$ (Note4,5)	-	32	42	nC
Gate-Source Charge	Q_{gs}		-	8	-	
Gate-Drain Charge	Q_{gd}		-	12	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=30V$ $I_D=25A$ $R_G=25\Omega$ (Note4,5)	-	20	50	ns
Turn-on Rise time	t_r		-	100	210	
Turn-off Delay time	$t_{d(off)}$		-	80	170	
Turn-off Fall time	t_f		-	85	180	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	1050	1365	pF
Reverse Transfer Capacitance	C_{riss}		-	70	90	
Output Capacitance	C_{oss}		-	460	600	
Source-Drain Diode Ratings						
Continuous Source Current	I_S	$V_{GS}<V_{th}$	-	-	50	A
Pulsed Source Current	I_{SP}		-	-	200	
Diode Forward Voltage	V_{SD}	$I_S=50A, V_{GS}=0V$	-	-	1.5	V
Reverse Recovery Time	t_{rr}	$I_S=50A, V_{GS}=0V$, $dI_S/dt=100A/\mu s$	-	50	-	ns
Reverse Recovery Charge	Q_{rr}		-	70	-	μC

Note 1) Repetivity rating : Pulse width limited by junction temperature.

Note 2) $L=230mH, I_S=50A, V_{DD}=25V, R_G=25\Omega$, Starting $T_j=25\text{ }^\circ\text{C}$.

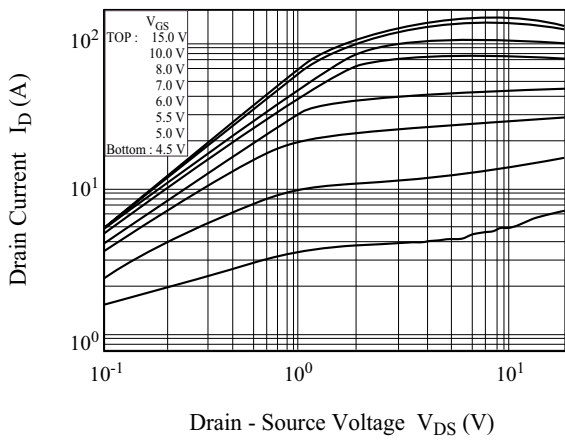
Note 3) $I_S \leq 50A, dI/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$, Starting $T_j=25\text{ }^\circ\text{C}$.

Note 4) Pulse Test : Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.

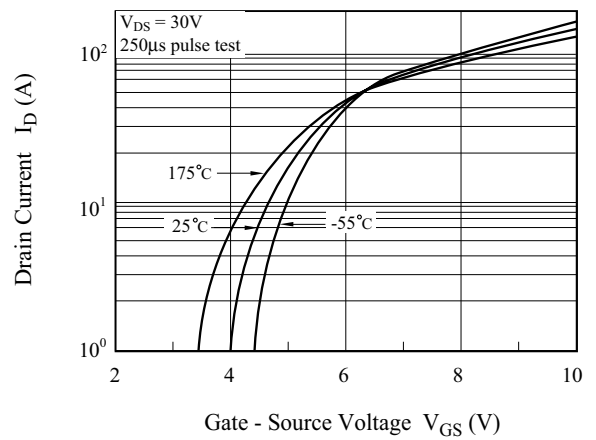
Note 5) Essentially independent of operating temperature.

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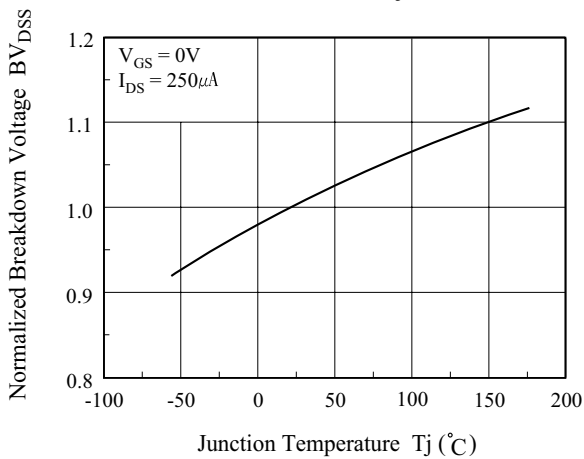
$I_D - V_{DS}$



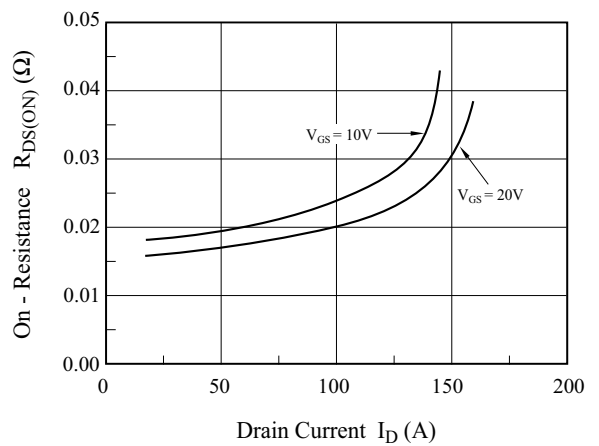
$I_D - V_{GS}$



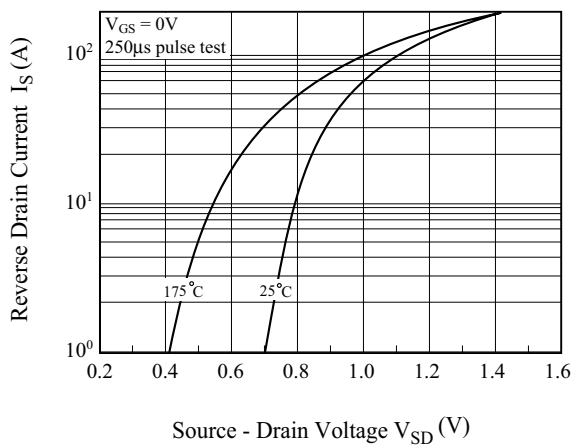
$BV_{DSS} - T_j$



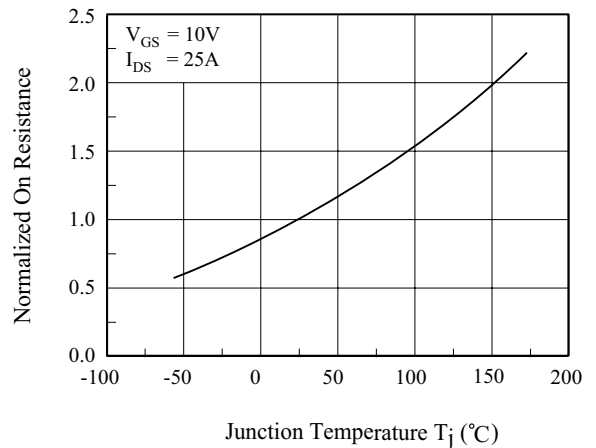
$R_{DS(ON)} - I_D$



$I_S - V_{SD}$

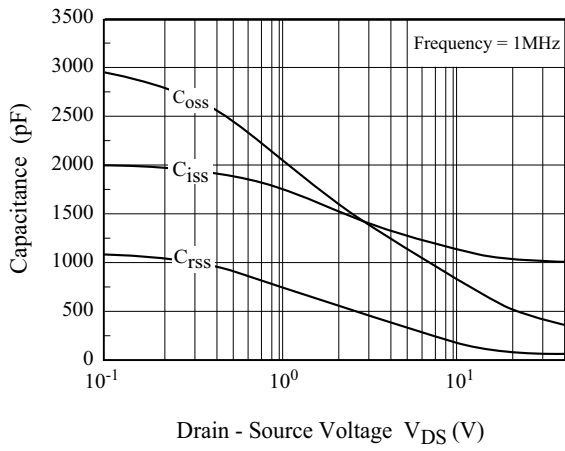


$R_{DS(ON)} - T_j$

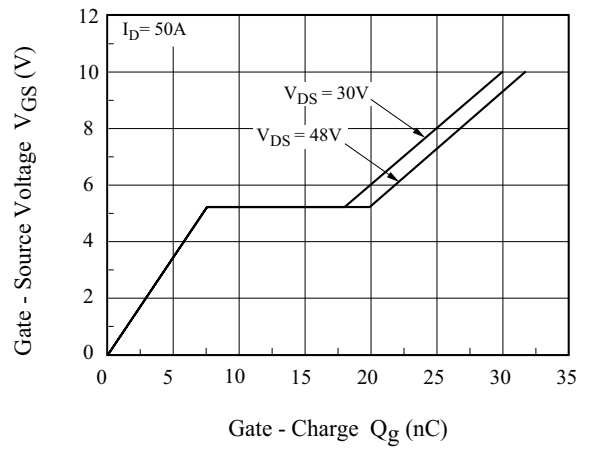


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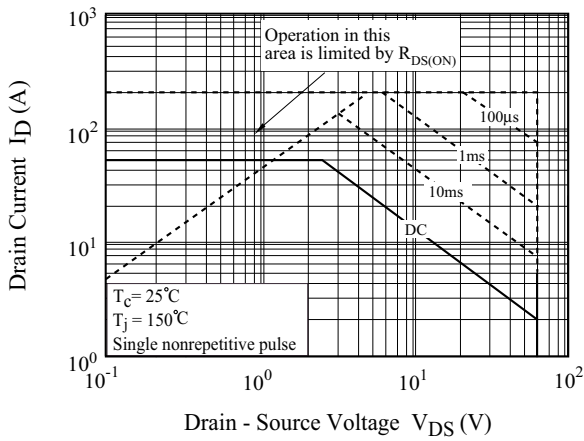
C - V_{DS}



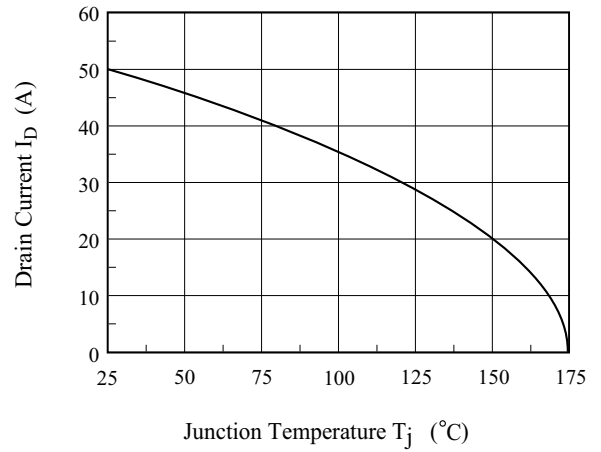
Q_g- V_{GS}



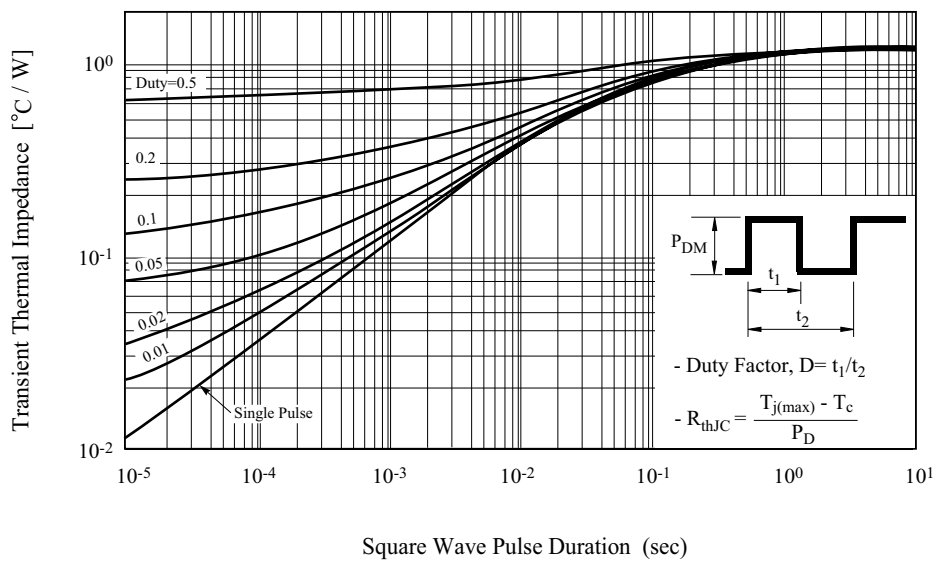
Safe Operation Area



I_D - T_j

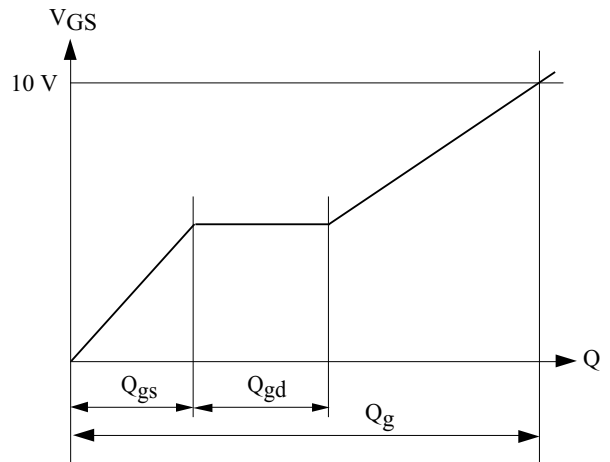
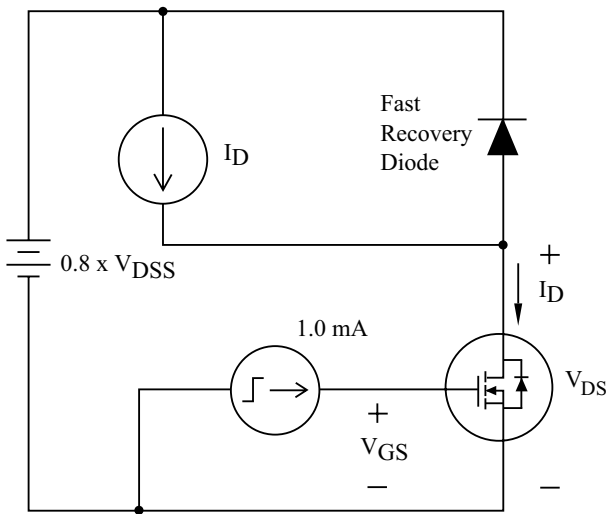


R_{th}

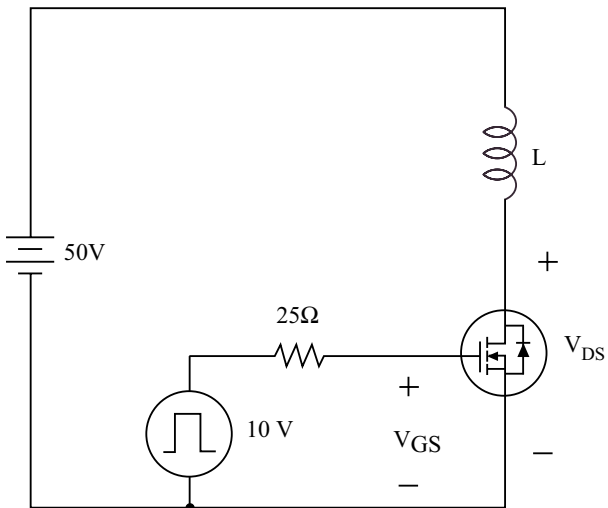


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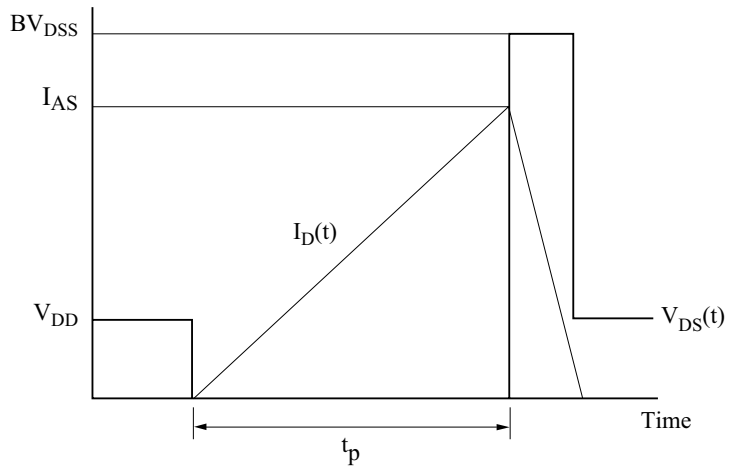
- Gate Charge



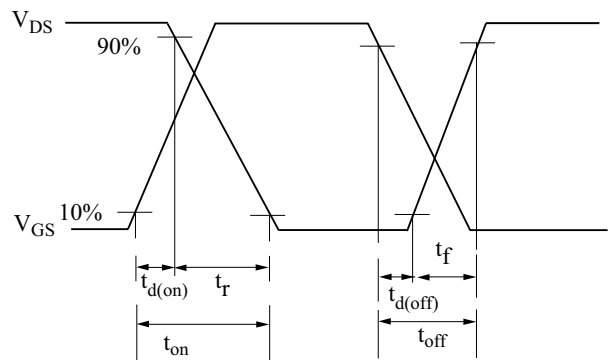
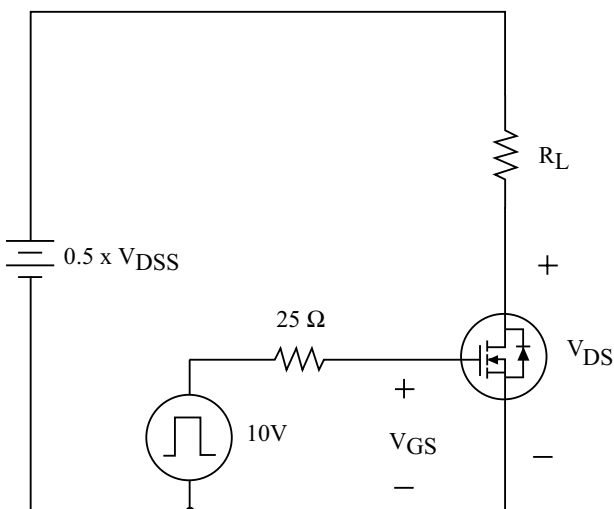
- Single Pulsed Avalanche Energy



$$E_{AS} = \frac{1}{2} I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



- Resistive Load Switching



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- Source - Drain Diode Reverse Recovery and dv/dt

